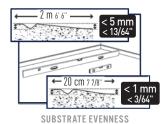
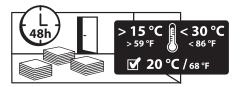
CONDITIONS	SUBSTRATES	ACCESSORIES INSTALLATION				
LAYING CONDITIO	NS					
TYPE OF INSTALLATION	Maintained with tackifier or loose-laid	Maintained installation : • Full bonding with tackifier • If surface <50 m ² : possibility to maintain with B-connect connectors Loose-lay installation allowed for surfaces <12 m ² The tiles must always be slightly compressed laterally.				
SUBSTRATE EVENNESS	Flatness requirement: < 5 mm / 2 meter ruler and < 1 mm / 20 cm ruler.	Flat, clean, sound, dry and solid				
STORAGE	At least 48 hrs prior to installation	Store the floor covering in the room where it is going to be laid. Do not stack more than five boxes high.				
LAYING TEMPERATURE	+ 15°C < T < + 30°C substrate temperature > 10°C	Ideally 20°C				
DIRECT SUNLIGHT (SUNNY AREAS, Bay windows, skylights, skydome)	Floor temperature < 60°C	To prevent the floor temperature from reaching excessive values (60 °C or above), direc sunlight on the floor should be obscured by curtains, blinds or other suitable protection.				
FIRST USE	Pedestrian traffic - 24 hours Installation of furniture - 48 hours	First use is immediate if the flooring is laid using B-connect connectors. In case of underfloor heating, wait 7 days before turning the heating back on.				
USAGE CONDITIO	NS					

USAGE TEMPERATURE	10 - 40°C	
CASTOR CHAIRS		Use is possible with Armonia 520 and 620 and only when installation is made with tackifier.

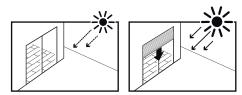




MAINTENANCE



STORAGE



DIRECT SUNLIGHT



IMPORTANT: The information in this document is valid from 24/01/2025 and is subject to change without prior notice. As we carry out continuous technical improvements, our customers should check with us that this document is still in force before starting any work.

CONDITIONS

SUBSTRATES

ACCESSORIES

INSTALLATION

SUBSTRATE

CONDITIONS

For installing this floor covering

Cement based substrate (concrete floor, cement based screed, anhydrite (calcium sulphate)-based screed)	Moisture content compliant with the relevant standards and regulation in the country of use, and always < 4% (80%RH) for cement based substrate and < 0.5% for an anhydrite-based substrate (the most stringent regulation applies). If necessary, prepare the substrate and apply a smoothing compound to remove any surface irregularities			
Ceramic tiles	If tile joints < 4 mm wide and < 1 mm deep, and no unevenness . Otherwise, apply a grouting product or levelling compound. If more than 10% of the room's surface is in bad condition, complete removal is necessary followed by new substrate preparation.			
Compact PVC/linoleum floor coverings	After examination and repair depending on the condition of the floor covering. If more than 10% is in bad condition, complete removal is necessary followed by new substrate preparation.			
Textile floor covering (carpet) / textile-backing PVC floorings / foam-backing PVC floorings / underlayers	Removal.			
Resin	There must be no defects in the resin, otherwise complete removal is necessary followed by new substrate preparation.			
Raised access floors	Deflection under the 2-m rule at any location on the raised floor surface must not exceed 2 mm. The unevenness between two adjacent floor slabs must be < 1 mm. Lay the flooring offsetting the joints of the tiles compared to the joints of the floor modules			
Laminated / floating parquet or wood panels	Removal.			
OSB	Treat any possible defects on the substrate (unevenness, joints between panels) then apply a fiber-reinforced levelling compound.			
Glued parquet or parquet nailed onto battens ventilated underneath	Allowed after treatment of possible defects (unevenness, open joints between planks, missing planks etc.)			
Wood based panels on joists or battens	Allowed after treatment of possible defects (joints, unevenness etc.)			
Water reversible underfloor heating	Allowed (fully bonded only). Heating must be turned off 48 hours before installation.			
Underfloor heating with circulating water, max temperature 28°C	Allowed (fully bonded only). Heating must be turned off 48 hours before installation.			
Radiant electric underfloor heating	Allowed (fully bonded only). Heating must be turned off 48 hours before installation.			

The preparation of the substrate must comply with the current relevant standards in the country of use.

For any information on product properties and usages, please refer to its technical datasheet: www.gerflor.fr



CONDITIONS	SUBSTRATES	ACCESSORIES	INSTALLATION		
TOOLS	Utility knife - Tape measure - Metal stra	ight edge.			
ADHESIVES	See Installation section				
FINISHES	Design skirting Ref. 6086 / MDF Design skirting Ref. 5947 – See installation guidelines [504A] and [504B]. Finishing profile: ramp 5-6 mm (aluminium) ref. 0505 When combined with flooring less than 3 mm thick, use transition profiles. Non-exhaustive list below: - Screw-on drilled profiles: Romus ref. 1940 et 2655 or Gradus ref. RT264 and RT 247 or Dinac ref. 2140090 - Multi-level threshold with invisible screws: Dinac ref. 2149090 - Transition profiles Gradus ref. ET804 et ET367				



SUBSTRATES

ACCESSORIES

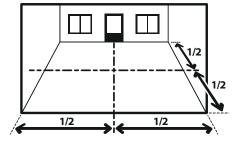
INSTALLATION



The floor covering should be examined prior to installation for any visible defects. The flooring must belong to the same production batch. If there are any visual defects, please notify GERFLOR and do not begin installation without its prior approval.

ADDHESIVE APPLICATION

- Mix the tiles from several different boxes from the same series.
- Mark out starting axes for laying the tiles according to the illustration opposite:
- Centre a row of tiles on the main axes.
- Check that the cut tiles around the room's edges will be larger than half a tile.

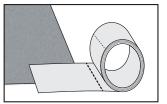


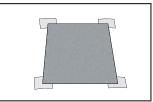
• Laying with tackifier

- Use an aqueous dispersion tackifier specially recommended for loose-lay carpet tile.
- Depending on the type and condition of substrate, the use of a primer might be recommended by the adhesive manufacturer.
- Apply the tackifier with a spatula or roller according to the manufacturer's recommendations. Refer to the technical datasheet.
- To avoid any permanent bonding, it is essential to allow a sufficient waiting time for the adhesive. The waiting time depends on the temperature, humidity level, the substrate's porosity and the amount of tackifier used.

• Installation with B-Connect connectors (ref 12500001), restricted to surfaces < 50 m²

- Cut the connectors according to the pre-cut dotted lines.
- As you lay, the connectors must be placed at the corners of the tiles so that one connector is connected to 4 tiles (or 2 tiles at the edges). The adhesive side of the connector is placed in contact with the underside of the tiles.
- In the absence of construction elements at the edge of the tiles able to provide lateral compression, apply a double-sided adhesive along the extremities of the rows.







CONDITIONS	SUBSTRATE	ES	ļ	CCESSORIES		INSTALLATION
INSTALLATION OF TILE	S					15 15 20 24 27 29 30 14 10 10 14 19 23 26 28 13 9 6 6 9 13 18 122 25
 Position the first tile where the Install the next tiles in a stair pressing each tile tightly again 	case configuration,					17 12 8 5 3 3 5 8 12 17 21 16 11 7 4 2 1 1 2 4 7 11 16 1 2 4 7 11 16 3 5 8 12 17 21 1 2 4 7 11 16 3 5 8 12 17 21 3 5 8 12 17 21
one. - Regularly check that the tiles aligned by running your finge the tiles.	are properly					
- Blocking: check that the edge The tiles must always be sligh deformation.	es of the tiles touch htly compressed late	properly . erally. How	ever, the p	pressure must r	not be to	oo high to avoid causing
- Tile laying direction for Armo = monolithic (in the same direc checkerboard pattern (at 90°). underneath the tiles.	tion) or in a	↓ ↓ ↓ ↓ ↓ ↓ Pose dans le	↓ ↓ ↓ ↓ ↓ ↓ même sens	$\begin{array}{cccccccccccccccccccccccccccccccccccc$		
- Tile laying direction for Armo monolithic (in the same directio checkerboard pattern (at 90°) o (random). Refer to the arrows u	n), in a or non directional	↓ ↓ ↓ ↓ ↓ ↓ Pose dans le	↓ ↓ ↓ ↓ ↓ ↓ même sens	$\begin{array}{c} \downarrow \rightarrow \downarrow \rightarrow \\ \rightarrow \downarrow \rightarrow \downarrow \\ \downarrow \rightarrow \downarrow \rightarrow \\ \rightarrow \downarrow \rightarrow \\ \hline Pose à 90^{\circ} \end{array}$	↑ − ↓ ↓ ↓ ↓ ↓ ↓ Pose set	$\begin{array}{ccc} & \uparrow & \leftarrow \\ - & \rightarrow & \downarrow \\ \downarrow & \leftarrow \\ \downarrow & \leftarrow \\ \downarrow & \leftarrow \\ \downarrow & \bullet & \downarrow \\ \end{array}$ ens aléatoire

• Peripheral cutting using the overlapping method. The cut tiles around the room's edges must be larger half a tile.

